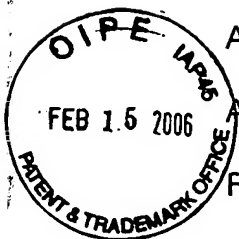


JPW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Applicants : Kumi OKADA et al.

Group Art Unit : 2626

Appl. No. : 10/800,706

Examiner : Not Yet Assigned

Filed : March 16, 2004

Confirmation No. : 1757

For : FACSIMILE MACHINE AND COMMUNICATION RESULT  
NOTIFYING METHOD

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
U.S. Patent and Trademark Office  
Customer Service Window, Mail Stop AMENDMENT  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314

Sir :

In accordance with the duty of disclosure under 37 C.F.R. §1.56 and §§1.97-1.98, and supplemental to the Information Disclosure Statements filed on April 22, 2005, January 7, 2005, September 1, 2004, and June 23, 2004, Applicant hereby submits the following documents:

A copy of a Japanese Notice of Reasons for Rejection dated December 16, 2003, together with an English language translation of the same, with respect to patent family member Japanese Patent Application No. 2002-240464, in which the following documents were cited:

(1) Japanese Laid-open Patent Publication No. HEI 6-350788. Applicant notes that this document was previously cited in the Information Disclosure Statement of April 22, 2005;

- (2) Japanese Laid-open Patent Publication No. HEI 2-172348, together with an English language abstract of the same;
- (3) Japanese Laid-open Patent Publication No. HEI 7-212394, together with an English language abstract of the same;
- (4) Japanese Laid-open Patent Publication No. HEI 5-37552, together with an English language abstract of the same; and
- (5) Japanese Laid-open Patent Publication No. HEI 8-32616. Applicant notes that this document was previously cited in the Information Disclosure Statement of April 22, 2005;

A copy of a Japanese Notice of Reasons for Rejection dated March 16, 2004, together with an English language translation of the same, with respect to patent family member Japanese Patent Application No. 2002-240464, in which the following documents were cited:

- (6) Japanese Laid-open Patent Publication No. HEI 5-103127 together with an English language abstract of the same; and
- (7) Japanese Laid-open Patent Publication No. HEI 6-276221, together with an English language abstract of the same.

A copy of a Japanese Notice of Reasons for Rejection dated March 9, 2004, together with an English language translation of the same, with respect to patent family member Japanese Patent Application No. HEI 10-282418, in which the following documents were cited:

- (8) Japanese Laid-open Patent Publication No. HEI 6-21968, together with an English language abstract of the same;

- (9) Japanese Laid-open Utility Model Publication No. HEI 5-28155 (which is related to utility Model Application No. 03-075846) , together with an English language abstract of the same;
- (10) Japanese Laid-open Patent Publication No. HEI 6-276221; (same as (7))
- (11) Japanese Laid-open Patent Publication No. HEI 6-253158, together with an English language abstract of the same;
- (12) Japanese Laid-open Patent Publication No. HEI 7-36801, together with an English language abstract of the same;
- (13) Japanese Laid-open Patent Publication No. HEI 7-219868, together with an English language abstract of the same;
- (14) Japanese Laid-open Patent Publication No. HEI 2-95084, together with an English language abstract of the same;
- (15) Japanese Laid-open Patent Publication No. HEI 8-116422, together with an English language abstract of the same;
- (16) Japanese Laid-open Patent Publication No. HEI 6-90253, together with an English language abstract of the same; and
- (17) Japanese Laid-open Patent Publication No. HEI 7-143309, together with an English language abstract of the same.

A copy of a Japanese Notice of Reasons for Rejection dated March 17, 2004, together with an English language translation of the same, with respect to patent family member Japanese Patent Application No. HEI 10-282418, in which the following documents were cited:

- (18) Japanese Laid-open Patent Publication No. HEI 6-319006 together with an English language abstract and partial translation of the same; and
- (19) Japanese Laid-open Patent Publication No. HEI 6-350775, together with an English language abstract and partial translation of the same.

The relevance of each document, as ascertained by the Japanese Examiners applying Japanese rules to the Japanese claims, is set forth in the Japanese Notices of Reasons for Rejection.

Applicants note that documents (1) and (5) were previously cited in the Information disclosure Statement of April 22, 2005, and thus copies are not provided herewith.


Applicants respectfully request that the Examiner consider the above material and cite the same. Copies of the above-noted documents (2)-(4) and (6)-(19) are attached hereto and the above-noted documents are listed on the attached PTO-1449 Form. The Examiner is requested to initial the appropriate spaces on the attached Form and to return a copy of the completed Form to Applicants with the next official communication in the present application.

Applicants additionally note that documents (1) and (5) were previously cited in an Information Disclosure Statement, and thus, no fee or certification is required to ensure consideration of these materials, as they were already considered.

Applicants note that an Office Action on the merits has not issued in the present application, and thus no fee is believed necessary to ensure consideration of the submitted material.

Should the Examiner have any questions, the Examiner is invited to  
contact the undersigned at the below-listed telephone number.

Respectfully Submitted,  
Kumi OKADA et al.

  
Bruce H. Bernstein  
Reg. No. 29,027

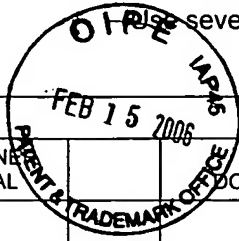
William Pieprz  
Reg. No. 33,630

February 15, 2006  
GREENBLUM & BERNSTEIN, P.L.C.  
1950 Roland Clarke Place  
Reston, VA 20191  
(703) 716-1191

FORM PTO-1449

U.S. Department of Commerce  
Patent and Trademark OfficeAtty. Docket No.  
P24952Application No.  
10/800,706INFORMATION DISCLOSURE STATEMENT  
BY APPLICANT

(Use several sheets if necessary)

Applicant  
Kumi OKADA et al.Filing Date  
March 16, 2004Group  
2626

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO
	6	- 3 5 0 7 8 8	12/22/94	JAPAN			
	2	- 1 7 2 3 4 8	07/03/90	JAPAN			
	7	- 2 1 2 3 9 4	08/11/95	JAPAN			
	5	- 3 7 5 5 2	02/12/93	JAPAN			
	8	- 3 2 6 1 6	02/02/96	JAPAN			
	5	- 1 0 3 1 2 7	04/23/93	JAPAN			
	6	- 2 1 9 6 8	01/28/94	JAPAN			
	5	- 2 8 1 5 5	04/09/93	JAPAN			
	6	- 2 7 6 2 2 1	09/30/94	JAPAN			
	6	- 2 5 3 1 5 8	09/09/94	JAPAN			
	7	- 3 6 8 0 1	02/07/95	JAPAN			
	7	- 2 1 9 8 6 8	08/18/95	JAPAN			
	2	- 9 5 0 8 4	04/05/90	JAPAN			
	8	- 1 1 6 4 2 2	05/07/96	JAPAN			
	6	- 9 0 2 5 3	03/29/94	JAPAN			
	7	- 1 4 3 3 0 9	06/02/95	JAPAN			
	6	- 3 1 9 0 0 6	11/15/94	JAPAN			X
	6	- 3 5 0 7 7 5	12/22/94	JAPAN			X

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	1	English Language Abstract of JP 2-172348.
	2	English Language Abstract of JP 7-212394.
	3	English Language Abstract of JP 5-37552.
	4	English Language Abstract of JP 5-103127.
	5	English Language Abstract of JP 6-21968.
	6	English Language Abstract of JP 5-28155.
	7	English Language Abstract of JP6-276221.
	8	English Language Abstract of JP6-253158.
	9	English Language Abstract of JP 7-36801.
	10	English Language Abstract of JP7-219868.

EXAMINER

DATE CONSIDERED

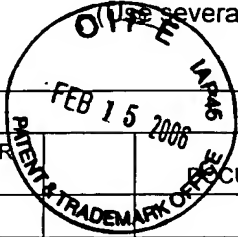
\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Application No.  
10/800,706

Applicant  
Kumi OKADA et al.

**Filing Date**  
March 16, 2004

Group  
2626

FILING DATE  
IF APPROPRIATE

TRANSLATION  
YES NO

16	English Language Abstract of JP6-350775.
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DATE CONSIDERED

\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.